Location-Selective CVD Synthesis of Circular MoS₂ Flakes with Ultrahigh Field-Effect Mobility

Presenter:

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Location: 122



The rise of 2D TMDs

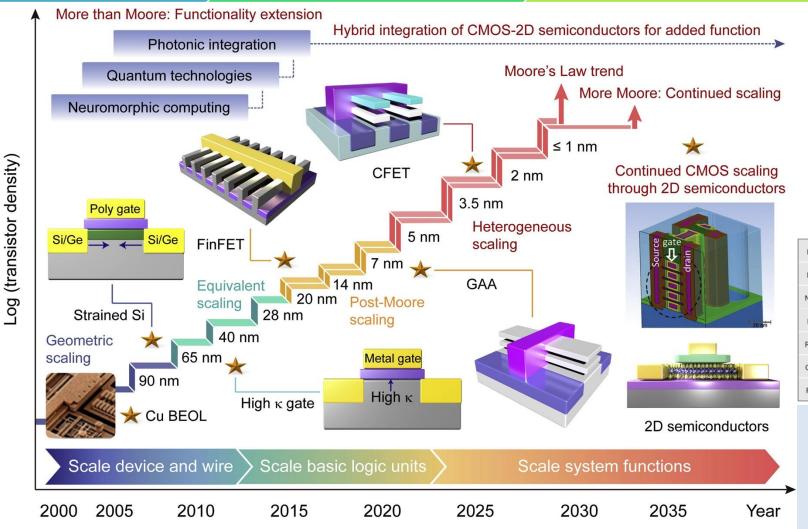
<u>Introductions</u>

Materials and methods

Results and discussion

Conclusion and highlights

6.5 Å

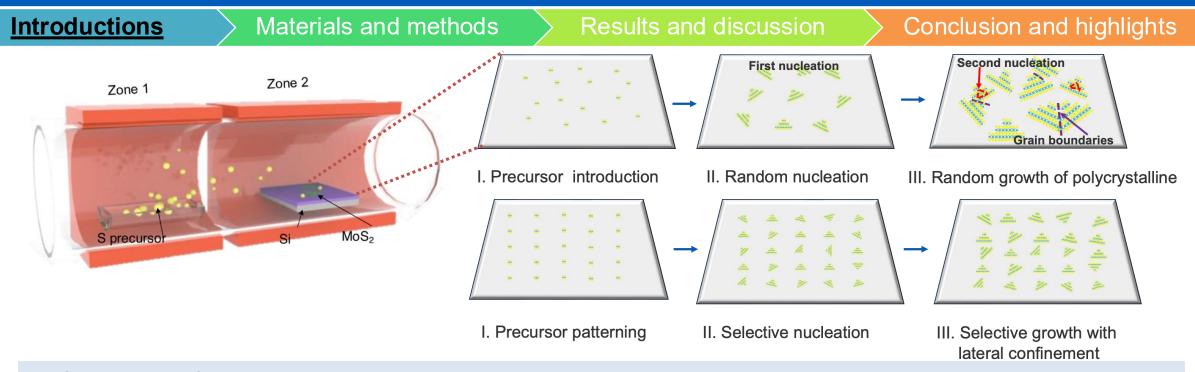


 Two-dimensional (2D) transition metal dichalcogenides (TMDs) have been extensively explored as channel materials for electronic devices.

M = Transition Meta

- 1. iScience Volume 25, Issue 10, 21 October 2022, 105160
- 2. Nature Nanotechnology volume 6, pages147–150 (2011)
- 3. Nano Convergence volume 2, Article number: 17 (2015)

Site-specific synthesis



Challenges for nanoelectronics:

Despite initial achievements in fundamental scientific research and device demonstrations, the growth of wafer-scale, single crystalline (SC) TMD films is a major obstacle to the advancement of commercially feasible TMD-based nanoelectronics.

> Solutions:

Site-specific growth \rightarrow allows micrometer scale controlled growth at selected locations which can be directly used as channel material for electronic devices.

Experiment process

Introductions

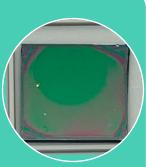
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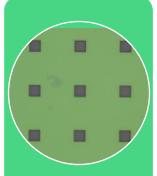
Conclusion and highlights



Substrate preparation



E-beam resists spin coating



E-beam lithography patterning



Mo precursor loading



Acetone liftoff E-beam resists



Selective MoS₂ CVD synthesis

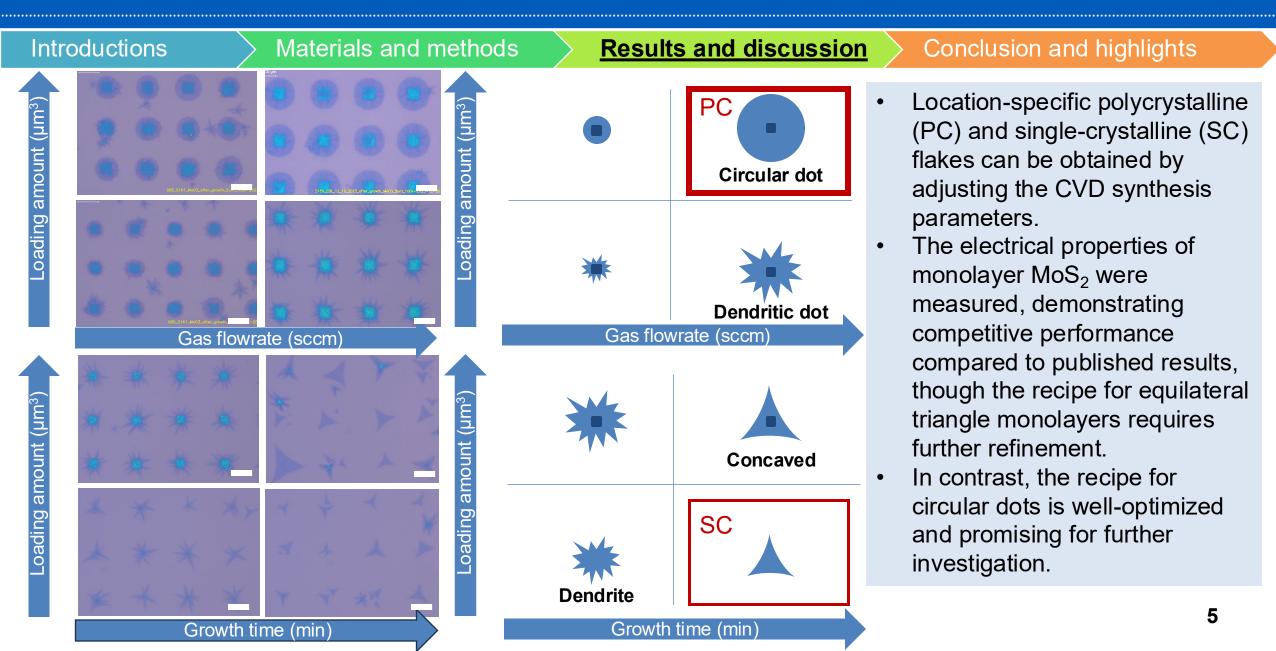


Materials Characteriz ation



Device fabrication and performance measurement

CVD parameter space exploration



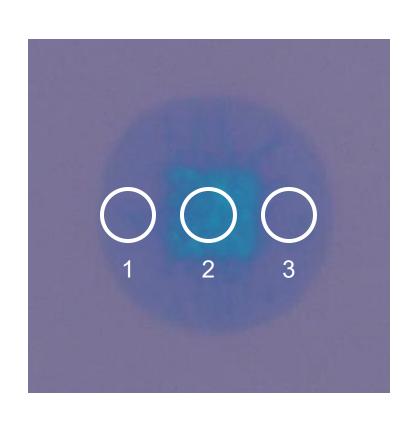
Material characterization - Raman spectroscopy

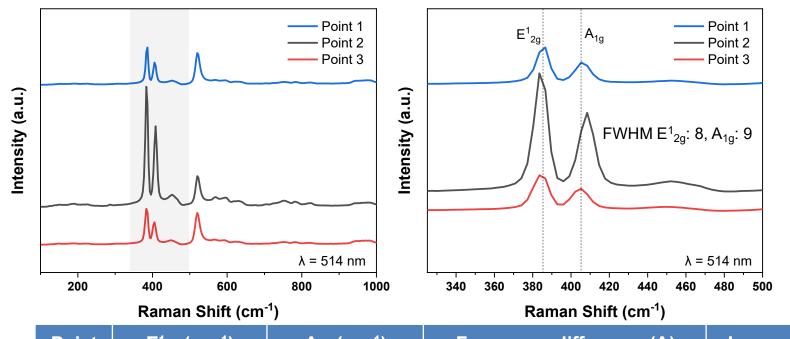
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| Point | E ¹ _{2g} (cm ⁻¹) | A _{1g} (cm ⁻¹) | Frequency difference (Δ) | Layers |
|-------|--|-------------------------------------|--------------------------|--------|
| 1 | 386.5 | 405.3 | 20.8 | 2 |
| 2 | 383.5 | 408.4 | 24.9 | > 3 |
| 3 | 383.5 | 405.3 | 21.9 | 3 |

The Raman analysis verifies that the flakes consist of MoS_2 , as indicated by the presence of characteristic peaks at $387cm^{-1}$ for E_{2g}^1 and $407cm^{-1}$ for A_{1g}^1 .

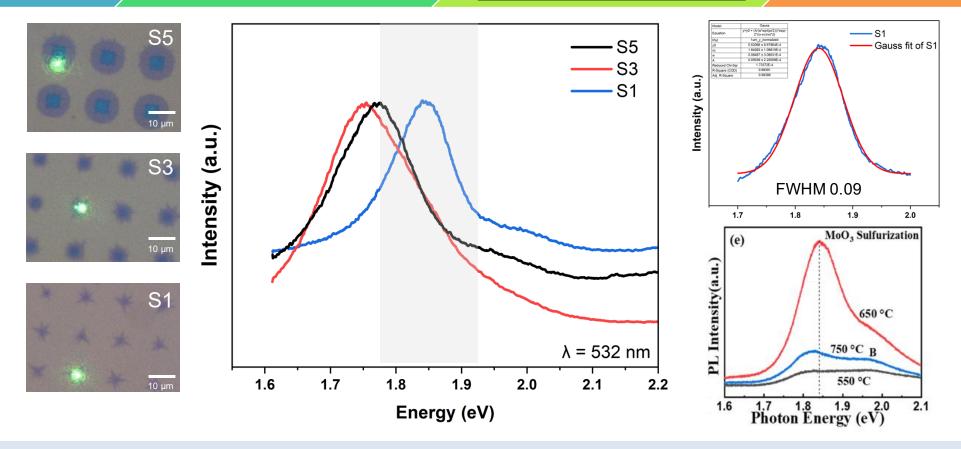
Material characterization - Photoluminescence spectroscopy

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The photoluminescence (PL) spectrum of monolayer molybdenum disulfide (MoS₂) exhibits peaks in the range of approximately 1.85 eV to 2.00 eV. The S1 region displayed monolayer/bilayer (ML/BL) flakes, while the S3 and S5 regions showed multilayer flakes.

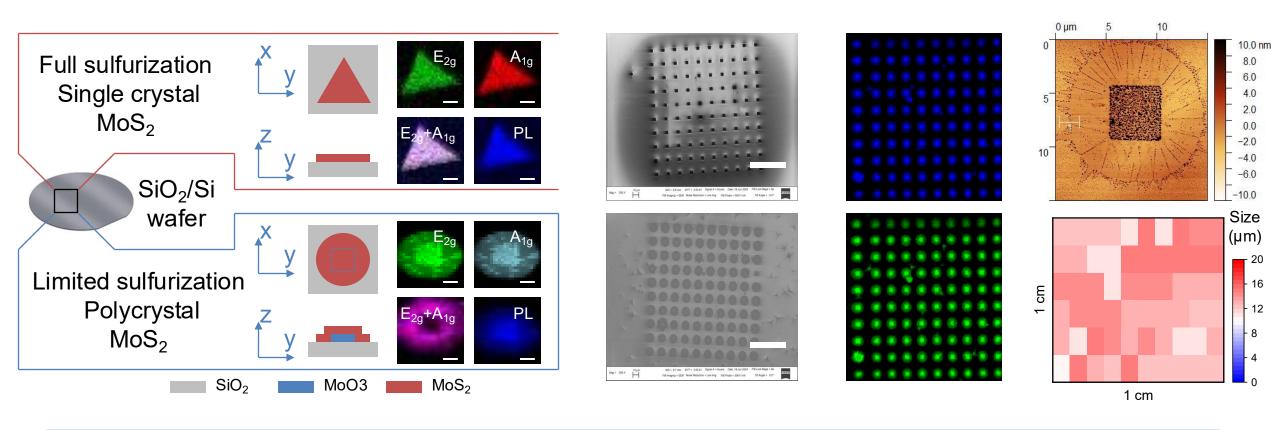
Material characterization - Array scale mapping

Introductions

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• The uniformity of the flakes can be assessed using 10 x 10 arrays through various characterization techniques such as SEM, AFM, Raman, and PL mapping.

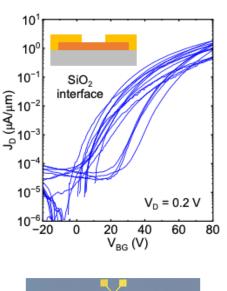
Material characterization - Carrier transport measurement

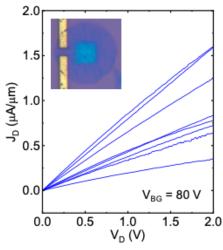


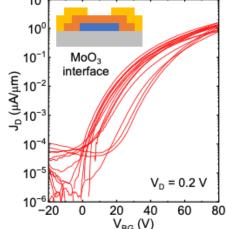
Materials and methods

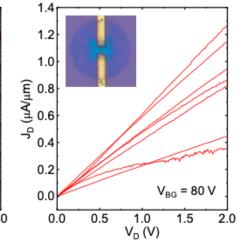
Results and discussion

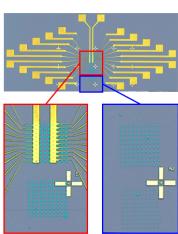
Conclusion and highlights

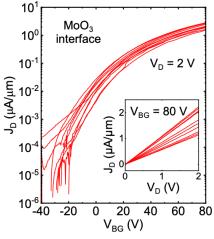


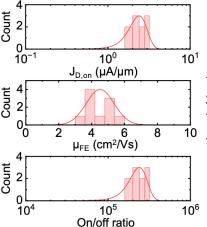


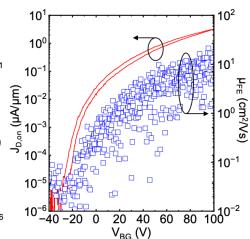












- A comparative investigation of MoS₂
 FETs with MoO₃ and SiO₂ dielectric interfaces is performed, focusing on output and transfer characteristics
 (J_D-V_D and J_D-V_{BG}).
- Both FET types show linear J_D-V_D characteristics, indicating Ohmic contact.
- Optimized MoS₂ FET achieves J_{D,on} of 3 μA/μm, μ_{FE} of 20 cm²/Vs, and on/off ratio up to 10⁶.

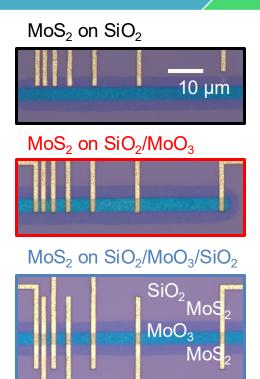
Material characterization - Transmission line measurement

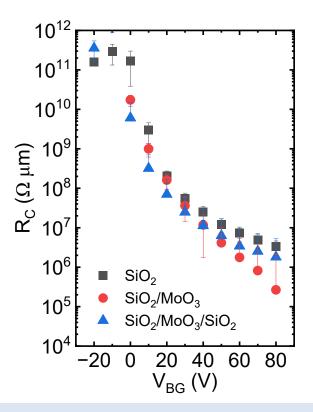
Introductions

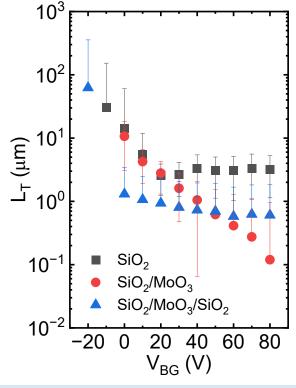
Materials and methods

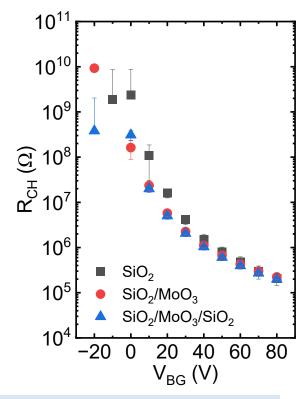
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- Well-controlled growth enables defining the geometry of as-grown MoS₂ in arbitrary shapes. No need for lithography or etching processes.
- Created a long MoO₃ ribbon (5 μm × 200 μm) for Transmission Line Measurement (TLM).
- Greater involvement of the MoO₃ interface (compared to SiO₂) improves metal contact conditions. Lower contact resistance (R_c) and transfer length (T_L). Maintains the MoS₂ channel resistance (R_{CH}).

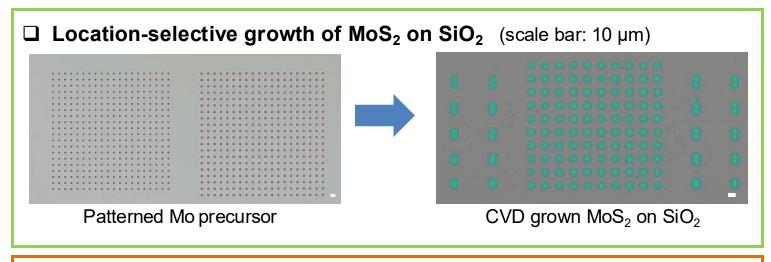
Research highlights

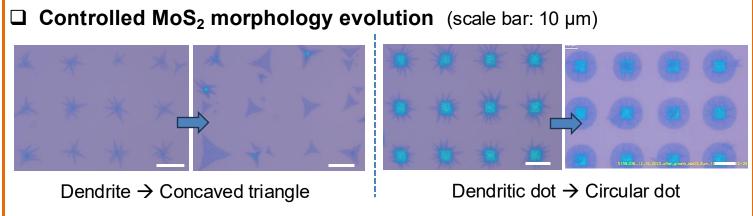
Introductions

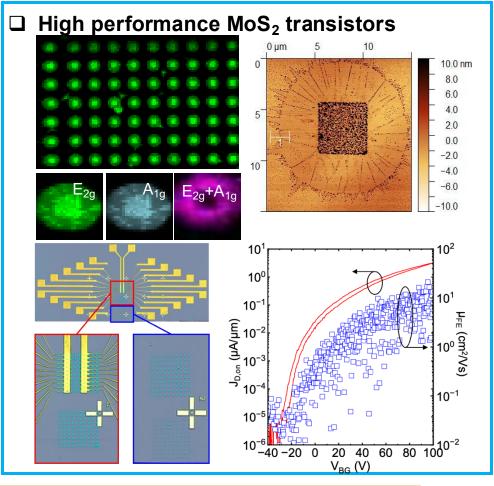
Materials and methods

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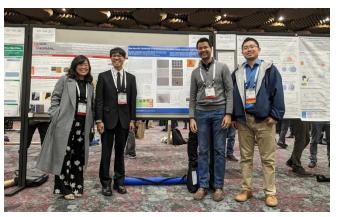


Successfully demonstrate the selective CVD growth of 2D MoS₂ arrays directly on SiO₂ substrates with controlled morphologies and excellent electronic quality (~20 cm²/Vs electron mobility).

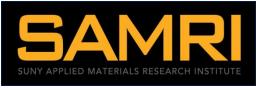
Acknowledgement

Team members

- Nano Energy Technology Laboratory
- **Emerging Nanoelectronics Research Group**

















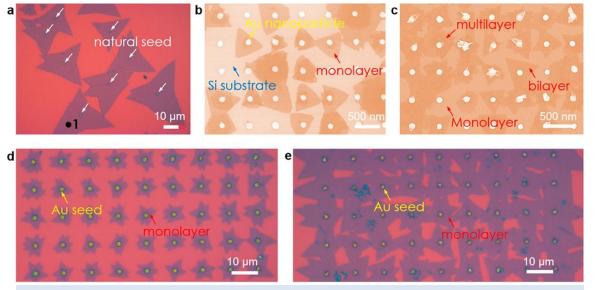
THANK YOU



SUPPORTING INFORMATION



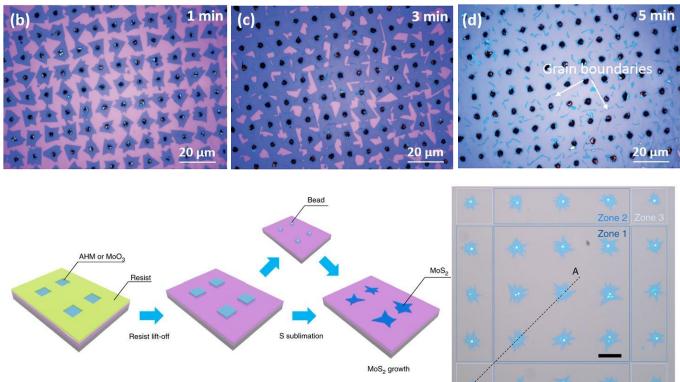
State of the art: site-specific synthesis



• Metal (e.g., Au) nanoparticles to seed the growth of MoS₂ monolayers and thereby provide a means to achieve controllable synthesis.

Issues

- Conventional photolithography crafts relatively large seed area → polycrystalline
- The metal seeds residuals will need extra steps to be removed during the fabrication
- 1. ACS Nano 2018, 12, 9, 8970–8976
- Adv. Mater. Interfaces 2020, 7, 2001549.
- Nature Communications volume 6, Article number: 6128 (2015)



Our approaches

 Exploit Electron beam lithographic patterning of the Mo precursors to enable micrometer scale MoS₂ nucleation at predefined locations on SiO₂ substrates

Process-Morphology-Carrier Transport Diagram

